

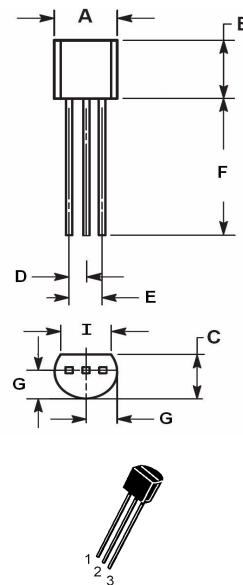
**Sensitive Gate Triacs
Silicon Bidirectional Thyristors**

**TRIACs
1.0 AMPERES RMS
400 thru 600 VOLTS**

FEATURES

- One-Piece, Injection-Molded Package
- Blocking Voltage to 600 Volts
- Sensitive Gate Triggering in Four Trigger Modes (Quadrants) for all possible Combinations of Trigger Sources, and especially for Circuits that Source Gate Drives
- All Diffused and Glassivated Junctions for Maximum Uniformity of Parameters and Reliability
- Improved Noise Immunity (dv/dt Minimum of 20 V/msec at 110°C)
- High Surge Current of 10 Amps
- Pb-Free Package

TO-92 (TO-226AA)



TO-92		
DIM.	MIN.	MAX.
A	4.45	4.70
B	4.32	5.33
C	3.18	4.19
D	1.15	1.39
E	2.42	2.66
F	12.7	-----
G	2.04	2.66
I	3.43	-----

All Dimensions in millimeter

PIN ASSIGNMENT	
1	Main Terminal 1
2	Gate
3	Main Terminal 2

MAXIMUM RATINGS (T_J= 25°C unless otherwise noticed)

Rating	Symbol	Value	Unit
Peak Repetitive Off- State Voltage (T _J = -40 to 125°C, Sine Wave, 50 to 60 Hz; Gate Open)	V _{DRM} , V _{RRM}	400 600	Volts
On-State RMS Current Full Cycle Sine Wave 50 to 60 Hz (T _c = 50°C)	I _{T(RMS)}	1.0	Amp
Peak Non-Repetitive Surge Current Full Cycle Sine Wave 60 Hz (T _J =25°C)	I _{TSM}	10.0	Amps
Circuit Fusing Consideration (t = 8.3 ms)	I ² t	0.40	A ² s
Peak Gate Power (t ≤2.0us ,T _c = 80°C)	P _{GM}	5.0	Watt
Average Gate Power (T _c = 80°C, t ≤8.3 ms)	P _{G(AV)}	0.1	Watt
Peak Gate Current (t ≤2.0us ,T _c = 80°C)	I _{GM}	1.0	Amp
Peak Gate Voltage (t ≤2.0us ,T _c = 80°C)	V _{GM}	5.0	Volts
Operating Junction Temperature Range	T _J	-40 to +110	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Notice: (1) V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Lead - Junction to Case - Junction to Ambient	RthJL RthJC RthJA	60 75 150	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

ELECTRICAL CHARACTERISTICS (T_c=25°C unless otherwise noted)

Characteristics	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Peak Repetitive Forward or Reverse Blocking Current (V _D =Rated V _{DRM} and V _{RRM} ; Gate OPen)	T _J =25°C	IDRM	----	----	10	uA
	T _J =110°C	IRRM	----	----	100	uA

ON CHARACTERISTICS

Peak Forward On-State Voltage (I _{TM} =± 1A Peak @T _p ≤2.0 ms, Duty Cycle ≤ 2%)	V _{TM}	----	----	1.9	Volts
Gate Trigger Current (V _D = 12 Vdc; R _L = 100 Ohms)	I _{GT1}	----	----	5.0	mA
	I _{GT2}	----	----	5.0	
	I _{GT3}	----	----	5.0	
	I _{GT4}	----	----	7.0	
Holding Current (V _D = 12 V, Initiating Current = ± 200 mA, Gate Open)	I _H	----	1.5	10	mA
Turn-On Time (V _D = Rated V _{DRM} , I _{TM} = 1.0 A pk, I _G = 25 mA)	t _{gt}	----	2	----	us
Gate Trigger Voltage (V _D = 12 Vdc; R _L =100 Ohms)	V _{GT1}	----	0.66	2.0	Volts
	V _{GT2}	----	0.77	2.0	
	V _{GT3}	----	0.84	2.0	
	V _{GT4}	----	0.88	2.5	
Latching Current (V _D =12V,I _G = 10 mA)	I _{L1}	----	1.6	15	mA
	I _{L2}	----	10.5	20	
	I _{L3}	----	1.5	15	
	I _{L4}	----	2.5	15	
Gate Non-Trigger Voltage (V _D = 12V, R _L = 100 Ohms , T _J =110 °C)	V _{GD}	0.1	----	----	Volts

DYNAMIC CHARACTERISTICS

Critical Rate of Rise of Off-State Voltage (V _D =Rated V _{DRM} ,Exponential Waveform, Gate Open, T _J =110°C)	dv/dt	20	60	----	V/us
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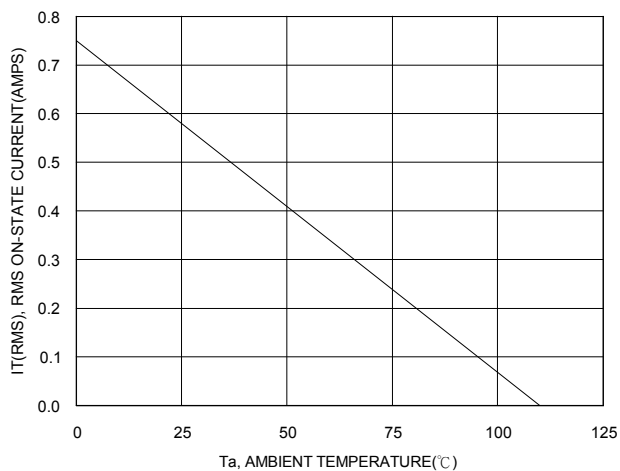


Figure 1. RMS Current Derating Versus Ambient Temperature

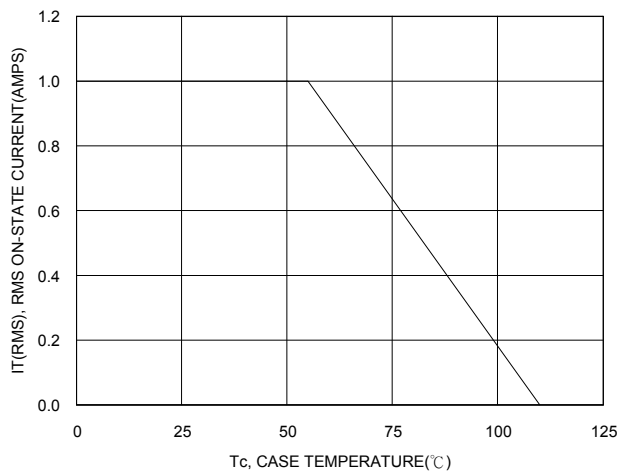


Figure 2. RMS Current Derating Versus Case Temperature

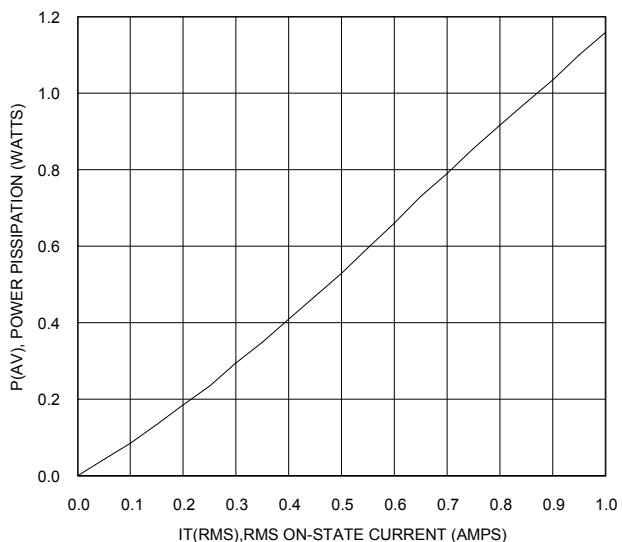


Figure 3. Power Dissipation

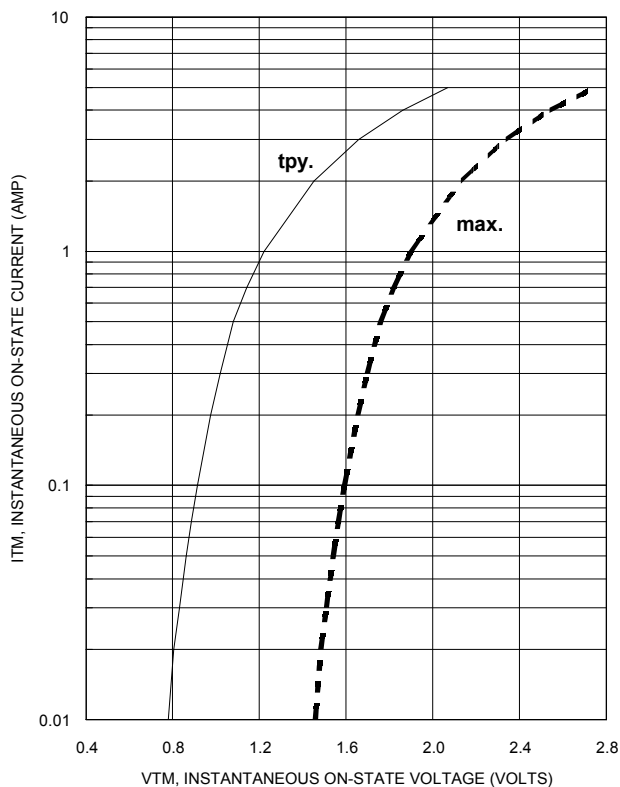


Figure 4. On-State Characteristics

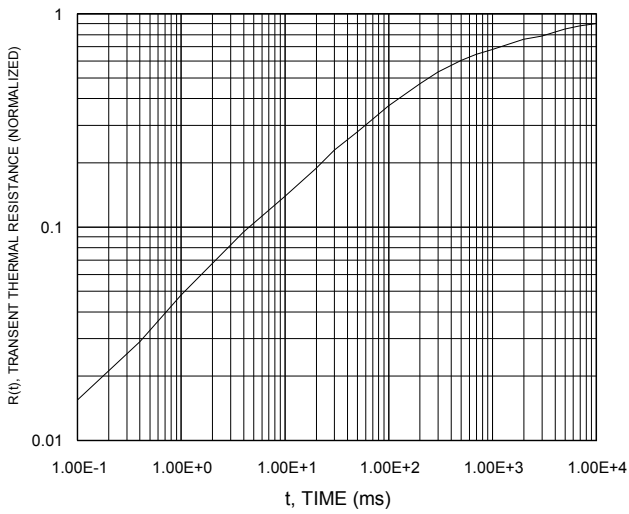


Figure 5. Transient Thermal Response

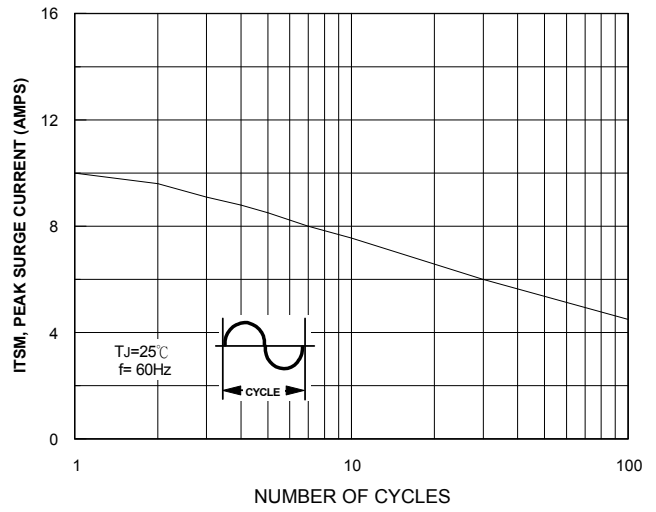


Figure 6. Maximum Allowable Surge Current

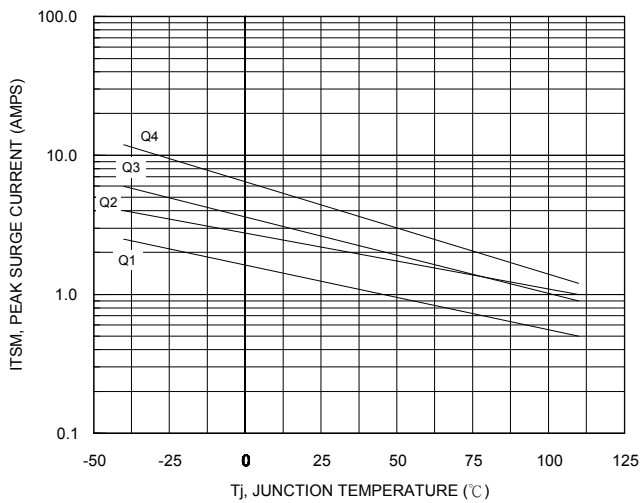


Figure 7. Typical Gate Trigger Current Versus Junction Temperature

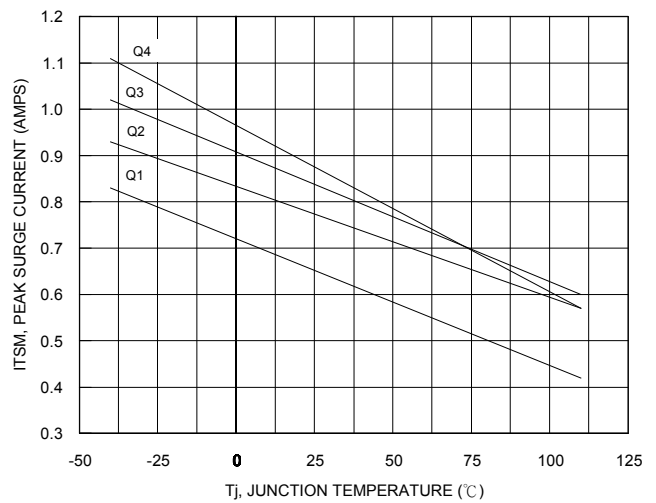


Figure 8. Typical Gate Trigger Voltage Versus Junction Temperature

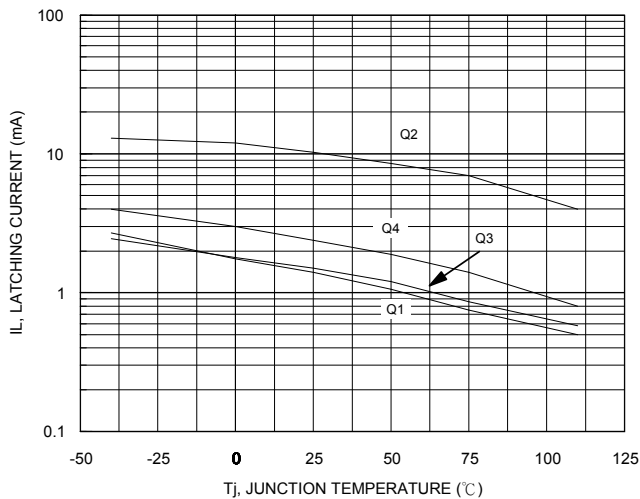


Figure 9. Typical Latching Current Versus Junction Temperature

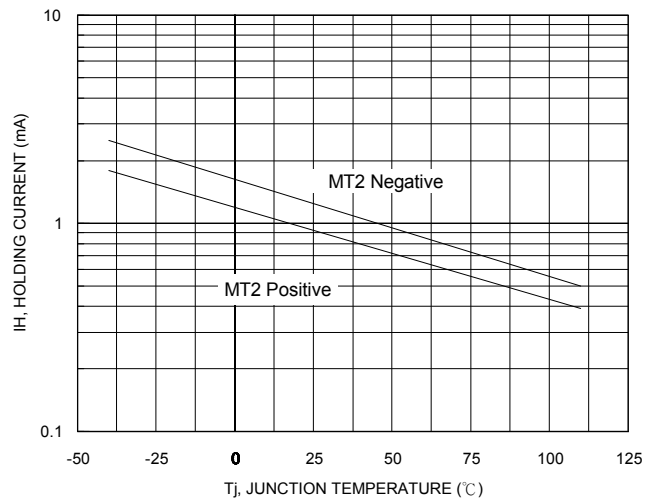


Figure 10. Typical Holding Current Versus Junction Temperature

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